

标 记
MARKECN编号/变更内容
ECN NO/DEFINITION修 改
REVISE日 期
DATE核 准
APPROVE

A

B

C

D

E

F

G

A

B

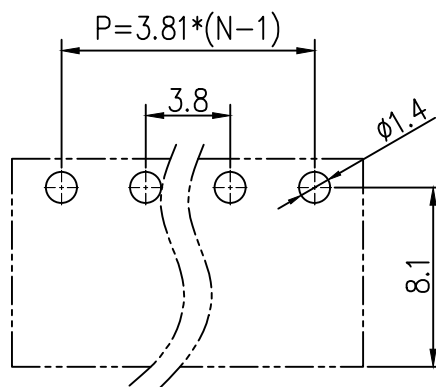
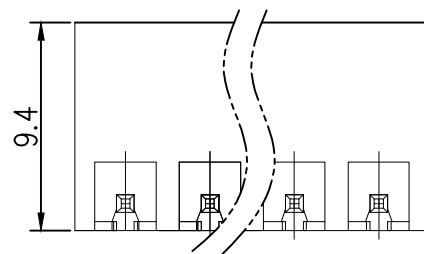
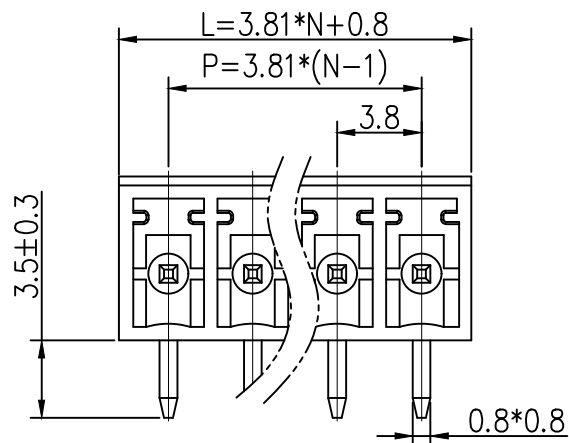
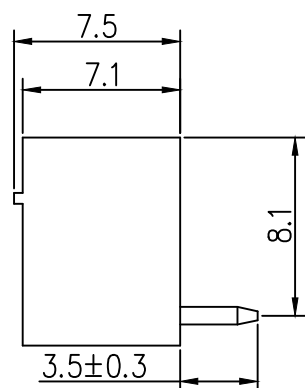
C

D

E

F

G



PCB LAYOUT

Materials and Electroplating

- ①. Plastic body: PA66
②. Solder pin: copper, Nickel tin plating

Electrical performance

Rated voltage: 300V

Rated current: 8A

Contact resistance: 20m Ω (Max)

Insulation resistance: 500M Ω \ DC500V

Voltage endurance: AC1500V \ 1Min

mechanical properties

Temperature range: -40 °C~+105 °C

Instantaneous temperature: +250 °C, 5 seconds

2	插针	铜	镀镍锡	
1	底座	PA66	绿色	
序号	品 名	材 质	电镀/颜色	备 注

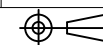


深圳市虹成电子有限公司

品 名 TITLE	接线端子
料 号 PART NO	HC-JXDZRC-3.81-11P

GENERAL TOLERANCES
(UNLESS SPECIFIED)比 例
SCALE

1:1



公差参数	公差	公差
Pin	DimP	DimL
2-6P	±0.10	±0.20
7-12P	±0.20	±0.30
13-18P	±0.25	±0.40
19-24P	±0.30	±0.50

单 位
UNIT

MM

制 图
DRAW

AhYe

张 数
PART NO

1 OF 1

审 核
CHECKED

夏操云

版 本
REV

A

批 准
APPROVE

赵亮亮

